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APPLICATION NO.	FILING	DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/626,330	07/24/2003		David J. Christie	AE2002-006CIP	1361
35487	7590	09/28/2005		EXAMINER	
JOHN D. P.		INTICTRIES IN	MCDONALD, RODNEY GLENN		
ADVANCED ENERGY INDUSTRIES, INC. 1625 SHARP POINT DR.			C.	ART UNIT	PAPER NUMBER
FORT COLI	INS, CO 80	525		1753	

DATE MAILED: 09/28/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary		Application No.	Applicant(s)	Applicant(s)				
		10/626,330	CHRISTIE, DAVID J.					
		Examiner	Art Unit					
		Rodney G. McDonald	1753					
Period fo	The MAILING DATE of this communication reply	n appears on the cover sheet wit	th the correspondence address					
WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR RECHEVER IS LONGER, FROM THE MAILINGS of time may be available under the provisions of 37 CONTROLOGICAL SIX (6) MONTHS from the mailing date of this communication period for reply is specified above, the maximum statutory per to reply within the set or extended period for reply will, by reply received by the Office later than three months after the red patent term adjustment. See 37 CFR 1.704(b).	IG DATE OF THIS COMMUNIC FR 1.136(a). In no event, however, may a re- on. period will apply and will expire SIX (6) MON statute, cause the application to become AB.	CATION. Sply be timely filed THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).					
Status								
1)	Responsive to communication(s) filed on	08 September 2005.						
<i>'</i> _	•	This action is non-final.						
, 	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is							
٠,۵	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Dispositi	on of Claims							
4)⊠	Claim(s) 1-12 is/are pending in the application	ation.	•					
•	4a) Of the above claim(s) is/are withdrawn from consideration.							
	Claim(s) is/are allowed.							
·)⊠ Claim(s) <u>1-12</u> is/are rejected.							
·	Claim(s) 1-12 is/are rejected: Claim(s) is/are objected to.							
	Claim(s) are subject to restriction a	and/or election requirement.						
•	on Papers	•						
	·		·					
,—	The specification is objected to by the Exa	_	the Everniner					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.								
	Applicant may not request that any objection t							
441	Replacement drawing sheet(s) including the c		•					
11)[_]	The oath or declaration is objected to by the	ne Examiner. Note the attached	Office Action of form PTO-152.					
Priority u	ınder 35 U.S.C. § 119		•					
a)[Acknowledgment is made of a claim for fo All b) Some * c) None of: 1. Certified copies of the priority docu 2. Certified copies of the priority docu 3. Copies of the certified copies of the application from the International Base the attached detailed Office action for	ments have been received. ments have been received in Aperiority documents have been ureau (PCT Rule 17.2(a)).	oplication No received in this National Stage					
	•		•					
Attachmen		∧ □ ₁_₁_ · _ △	umman, (DTO 442)					
2) Notic 3) Inform	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-94 mation Disclosure Statement(s) (PTO-1449 or PTO/S r No(s)/Mail Date	Paper No(s	ummary (PTO-413))/Mail Date formal Patent Application (PTO-152)					

U.S. Patent and Trademark Office PTOL-326 (Rev. 7-05)

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DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-12 rejected under 35 U.S.C. 103(a) as being unpatentable over Chistyakov (U.S. Pat. 6,896,773) in view of Kouznetsov et al. "A novel pulsed magnetron sputter technique utilizing very high target power densities", Surface and Coatings Technology 122 (1999) 290-293 and Manley et al. (U.S. Pat. 5,682,067).

Regarding claims 1, 8, Chistyakov teach in Fig. 4 an apparatus and method for sputter deposition by providing a plasma chamber 202 with a sputtering gas source 208 for providing the sputtering gas. The chamber includes a sputtering target 220 for depositing material on the substrate. A pulsed power supply 234 is provided. The pulsed power source 234 can generate a weakly ionized plasma and subsequently generate a highly ionized plasma avoiding arc discharge. The target is sputtered to form a film on the surface of the substrate. (See Fig. 4; Column 5 lines 60-68; Column 6 lines 11-32; Column 6 lines 40-47; Column 7 lines 53-61; Column 8 lines 53-57; Column 8 lines 65-68; Column 9 lines 1-12; Column 9 lines 42-54; Column 3 lines 12-16)

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Regarding claims 3, 9, the voltage rate of ride of the voltage pulse is controlled to avoid adopting an arc state and produces a highly ionized plasma. (Fig. 6; Column 14 lines 64-67; Column 15 lines 1-65)

Regarding claims 5, 11, the magnitude of the voltage pulse is limited to prevent arc discharge. (Column 14 lines 64-67; Column 15 lines 1-65)

The differences between Chistyakov and the present claims is that the pulse power source being a DC power source is not discussed (Claim 1), the peak power density is not discussed (Claim 2), controlling the voltage rate of rise of the voltage pulse by utilizing a circuit comprising a resistor in series with a capacitor (Claim 4, 10), controlling the magnitude of the voltage pulse by utilizing a circuit comprising a resistor in series with a capacitor is not discussed (Claim 6, 10) and where the magnitude of the voltage pulse is limited using a circuit comprising a reverse biased diode, a capacitor, and a clamp voltage supply is not discussed (Claim 7, 12).

Regarding the pulse power source being a DC power source of claim 1, Kouznetsov et al. teach providing a plasma chamber with a sputtering of argon therein. A material target of copper is provided. A DC pulsed power supply was applied to the target in order to ionize a significant amount of copper (about 70%). The copper is deposited on substrate holders. (See page 290, 291, 293) Kouznetsov et al. teach the DC pulse power delivers power pulses up to 2.4 MW and has target power densities of 0.6-2.8 kW/cm². (See Page 291)

Regarding claim 2, Kouznetsov et al. teach that the target power densities can be 0.6-2.8 kW/cm². (See Page 291)

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The motivation for utilizing a DC pulsed power with particular target densities is that it allows for filling high aspect ratio holes. (See Kouznetsov abstract)

Regarding the circuit comprising a resistor in series with a capacitor for controlling the voltage rate of rise of the voltage pulse of claims 4 and 10, Manley et al. suggest capacitor 32 and resistor 38 for controlling the voltage. (Column 4 lines 3-16)

Regarding the circuit comprising a resistor in series with a capacitor for controlling the magnitude of the voltage pulse of claims 6 and 10, Manley et al. suggest a capacitor 30 and diode 34 for limiting the voltage. (Column 4 lines 31-35)

Regarding the use of a circuit comprising a reverse biased diode, a capacitor and a clamp voltage supply for limiting the voltage of claims 7 and 12, Manley suggest a capacitor 30, a diode 34 and clamping voltage (i.e +/-) for limiting voltage. (Column 4 lines 31-35; Column 11 lines 55-58)

The motivation for providing a circuit comprising a resistor in series with a capacitor for controlling the voltage rate of rise of the voltage pulse, for providing a circuit comprising a resistor in series with a capacitor for controlling the magnitude of the voltage pulse and for using a circuit comprising a reverse biased diode, a capacitor and a clamp voltage supply for limiting the voltage is that it allows for limiting the voltage applied to an electrode. (Column 4 lines 31-35)

Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to have modified Chistyakov by utilizing a dc pulse power source and a particular power density as taught by Kouznetsov and to have provided a circuit comprising a resistor in series with a capacitor for controlling the voltage rate of

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rise of the voltage pulse, to have provided a circuit comprising a resistor in series with a capacitor for controlling the magnitude of the voltage pulse and utilized a circuit comprising a reverse biased diode, a capacitor and a clamp voltage supply for limiting the voltage as taught by Manley et al. because it allows for filling high aspect ratio holes and for limiting the voltage applied to an electrode.

Double Patenting

The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. See *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re Vogel*, 422 F.2d 438, 164 USPQ 619 (CCPA 1970);and, *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent is shown to be commonly owned with this application. See 37 CFR 1.130(b).

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

Claims 8-12 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-7 of U.S. Patent No. 6,808,607 in view of Chistyakov (U.S. Pat. 6,896,773).

Claims 1-7 of U.S. Pat. No. 6,808,607 teach a plasma chamber, a material target, a DC pulsed power supply, and a pulsing circuit with pulse shaping means. (Claims 1-7)

The differences between U.S. Pat. No. 6,808,607 and the present claims is that the ionizing without first adopting an arc discharge state is not discussed.

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Chistyakov is discussed above and teach achieving a highly ionized state without first adopting an arc discharge state. (See Chistyakov discussed above)

The motivation for achieving a highly ionized state without first adopting an arc discharge state is that it allows for increasing sputtering rate. (Column 2 lines 38-56)

Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to have modified U.S. Pat. 6,808,607 by achieving a highly ionized state without first adopting an arc discharge state as taught by Chistyakov because it allows for increasing sputtering rate.

Response to Arguments

Applicant's arguments filed September 8, 2005 have been fully considered.

Sellers and Gruen have been withdrawn. Kouznetsov is still applied to teach other limitations in the claims but is not applied as a 102 reference or a primary reference under 103.

Applicant's argument is drawn to the fact that the references cited in the previous office action do not teach adopting a state of high ionization without first adopting an arc discharge. It is agreed that Sellers, Gruen and Kouznetsov do not suggest such a feature. However Chistyakov has been cited to suggest a feature where a plasma adopts a high ionization state without adopting arc discharge. While Applicant's parent application/patent has an earlier filing date than Chistyakov, Applicant's parent application/patent does not include reference to having the plasma first adopt a state of high ionization without first adopting an arc discharge and therefore Chistyakov is

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applicable to Applicant's present application which was filed after the filing date of the Chistyakov patent.

This action will be made NON-FINAL based on the newly cited reference to Chistyakov.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Rodney G. McDonald whose telephone number is 571-272-1340. The examiner can normally be reached on M- Th with Every other Friday off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nam X. Nguyen can be reached on 571-272-1342. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Rodney G. McDonald Primary Examiner

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RM September 22, 2005